

(V) Preliminary Specification
() Final Specification

Module	21.5" Color TFT-LCD
Model Name	P215HVN01.2

Customer	Date
Approved by	
Note: This Specific change with	

Approved by	Date
<u>CT Wu</u>	<u>Jan 13, 2021</u>
Prepared by	Date
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Record of Revision

Version	Date	Page	Old description	New Description	Remark
0.0	2021/1/13			Preliminary Specification	



1 Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open or modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) In case a TFT-LCD Module has to be put back into the packing container slot after once it was taken out from the container, do not press the center of the LED lightbar edge. Otherwise the TFT-LCD Module may be damaged.
- 10) Insert or pull out the interface connector, be sure not to rotate nor tilt it of the TFT-LCD Module.
- 11) Do not twist nor bend the TFT -LCD Module even momentary. It should be taken into consideration that no bending/twisting forces are applied to the TFT-LCD Module from outside. Otherwise the TFT-LCD Module may be damaged.
- 12) Please avoid touching COF position while you are doing mechanical design.
- 13) When storing modules as spares for a long time, the following precaution is necessary: Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keep the temperature between 5°C and 35°C at normal humidity.



2 General Description

This specification applies to the 21.5 inch wide Color a-Si TFT-LCD Module T215HVN01.1. The display supports the Full HD - 1920(H) x 1080(V) screen format and 16.7M colors (8 bits RGB data input). The input interface is Dual channel LVDS and this module doesn't contain an driver board for backlight.

2.1 Display Characteristics

The following items are characteristics summary on the table under 25°C condition:

ITEMS	Unit	SPECIFICATIONS
Screen Diagonal	[mm]	546.86 (21.53")
Active Area	[mm]	476.64 (H) x 268.11 (V)
Pixels H x V	-	1920(x3) x 1080
Pixel Pitch	[um]	248.25 (per one triad) ×248.25
Pixel Arrangement	-	R.G.B. Vertical Stripe
Display Mode	-	VA Mode, Normally Black
White Luminance (Center)	[cd/m ²]	250 (Typ.)
Contrast Ratio	-	3000 (Typ.)
Response Time	[msec]	18ms (Typ., on/off)
Power Consumption	[Watt]	14.3 (Typ.)
(LCD Module + Backligh unit)		LCD module: PDD (Typ.)= 3.1 @ all white pattern,Fv=60Hz
		Backlight unit : P _{BLU} (Typ.) =11.2 @Is=60mA
Weight	[Grams]	1670
Outline Dimension	[mm]	495.6(H) × 292.2(V) × 10.6(D) Typ.
Electrical Interface	-	Dual channel LVDS, 8 bits RGB data input
Support Color	-	16.7M colors
Surface Treatment	-	Anti-Glare, 3H
Temperature Range		
Operating	[°C]	0 to +50
Storage (Shipping)	[°C]	-20 to +60
RoHS Compliance	-	RoHS Compliance
TCO Compliance	-	TCO 7.0 Compliance



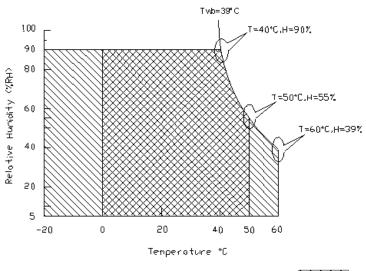
2.2 Absolute Maximum Rating of Environment

Permanent damage may occur if exceeding the following maximum rating.

		,	0		
Symbol	Description	Min.	Max.	Unit	Remark
TOP	Operating Temperature	0	+50	[°C]	Note 2-1
TGS	Glass surface temperature (operation)	0	+65	[°C]	Note 2-1 Function judged only
HOP	Operation Humidity	5	90	[%RH]	Note 2-1
TST	Storage Temperature	-20	+60	[°C]	
HST	Storage Humidity	5	90	[%RH]	

Note 2-1: Temperature and relative humidity range are shown as the below figure.

- 1. 90% RH Max (Ta \leq 39 $^{\circ}$ C)
- 2. Max wet-bulb temperature at 39 $^{\circ}$ C or less. (Ta \leq 39 $^{\circ}$ C)
- 3. No condensation



Operating Range

Storage Range

+



2.3 Optical Characteristics

The optical characteristics are measured on the following test condition.

Test Condition:

1. Equipment setup: Please refer to Note 2-2.

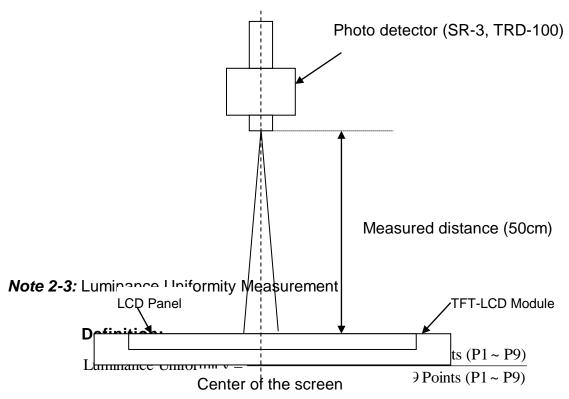
2. Panel Lighting time: 30 minutes

3. VDD=5.0V, Fv=60Hz,Is=60mA,Ta=25 $^{\circ}$ C

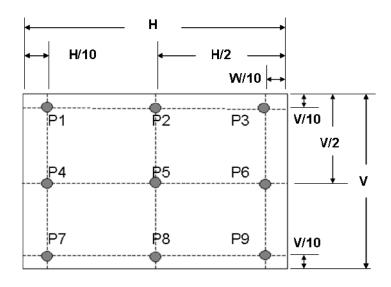
Symbol	Descriptio	Min.	Тур.	Max.	Unit	Remark	
L _w	White Luminance (Center of screen)			250	-	[cd/m2]	Note 2-2 By SR-3
L _{uni}	Luminance Uniformit	Luminance Uniformity (9 points)			-	[%]	Note 2-3 By SR-3
CR	Contrast Ratio (Cente	er of screen)	2000	3000	-	-	Note 2-4 By SR-3
θ_{R}	Horizontal Viewing Angle	Right	75	89	-		•
θ_{L}	(CR=10)	Left	75	89	-		
Фн	Vertical Viewing Angle	Up	75	89	-		
Φ_{L}	(CR=10)	Down	75	89	-	[degree]	Note 2-5
θ_{R}	Horizontal Viewing Angle	Right	75	89	-	[]	By SR-3
θ_{L}	(CR=5)	Left	75	89	-		
Φ_{H}	Vertical Viewing Angle	Up	75	89	-		
Φ_{L}	(CR=5)	Down	75	89	-		
T_R		Rising Time	-	13	28		
T _F	Response Time	Falling Time	-	5	8	[msec]	Note 2-6
-		Rising + Falling	-	18	36		By TRD-100
R _x		Red x	0.622	0.652	0.682		
R_y		Red y	0.305	0.335	0.365		
G _x		Green x	0.291	0.321	0.351		
G_y	Color Coordinates	Green y	0.595	0.625	0.655		
B _x	(CIE 1931)	Blue x	0.123	0.153	0.183	-	By SR-3
Ву		Blue y	0.037	0.067	0.097		
W _x		White x	0.283	0.313	0.343		
Wy		White y	0.299	0.329	0.359		
NTSC Area Ratio				72		[%]	By SR-3
СТ	Crosstalk	-	-	2.0	[%]	Note 2-7 By SR-3	
F _{dB}	Flicker (Center of	screen)	-	-	-20	[dB]	Note 2-8 By SR-3



Note 2-2: Equipment setup :



a. Test pattern: White Pattern



Note 2-4: Contrast Ratio Measurement

Definition:



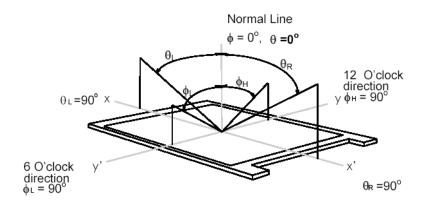
Contrast Ratio =
$$\frac{\text{Luminance of White pattern}}{\text{Luminance of Black pattern}}$$

a. Measured position: Center of screen (P5) & perpendicular to the screen ($\theta = \Phi = 0^{\circ}$)

Note 2-5: Viewing angle measurement

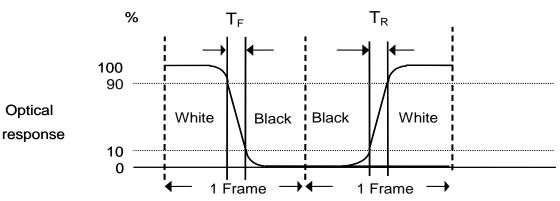
Definition: The angle at which the contrast ratio is greater than 10 & 5.

a. Horizontal view angle: Divide to left & right ($\theta_L \& \theta_R$) Vertical view angle: Divide to up & down ($\Phi_H \& \Phi_L$)



Note 2-6: Response time measurement

The output signals of photo detector are measured when the input signals are changed from "Black" to "White" (rising time, T_R), and from "White" to "Black" (falling time, T_F), respectively. The response time is interval between the 10% and 90% of optical response. (*Black & White color definition: Please refer section 3.4.3*)





Note 2-7: Crosstalk measurement

Definition:

 $CT = Max. (CT_H, CT_V);$

Where

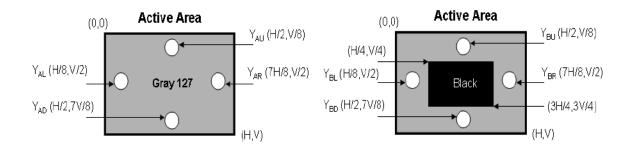
a. Maximum Horizontal Crosstalk:

$$CT_H = Max. (|Y_{BL} - Y_{AL}| / Y_{AL} \times 100 \%, |Y_{BR} - Y_{AR}| / Y_{AR} \times 100 \%);$$

Maximum Vertical Crosstalk:

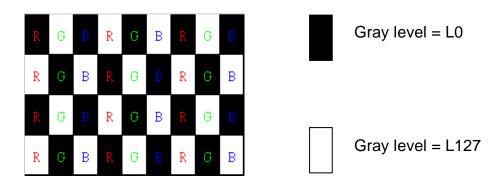
$$CT_V = Max. (|Y_{BU} - Y_{AU}| / Y_{AU} \times 100 \%, |Y_{BD} - Y_{AD}| / Y_{AD} \times 100 \%);$$

b. Y_{AU} , Y_{AD} , Y_{AL} , Y_{AR} = Luminance of measured location without Black pattern Y_{BU} , Y_{BD} , Y_{BL} , Y_{BR} = Luminance of measured location with Black pattern



Note 2-8: Flicker measurement

a. Test pattern: It is listed as following.



R: Red, G: Green, B:Blue

b. Measured position: Center of screen (P5) & perpendicular to the screen $(\theta=\Phi=0^{\circ})$



2.4 Mechanical Characteristics

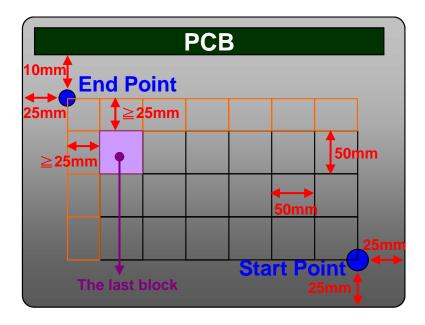
Symbol	Description	Min.	Max.	Unit	Remark
P_{bc}	Backside Compression	2.5		[Kgf]	Note 2-9

Note 2-9: Test Method:

The point is at a distance from right-downside 25mm x 25mm defined as the Start Point of Measure Points, and the point is at a distance 25mm from left-side & around 10mm from PCB defined as the End Point.

Align 50mm x 50mm block from Start Point on the Bezel Back, and the corners of each block are Measure Points.

If the distance from the last block to each side of the End Point \geq 25mm, add other blocks to make sure that most area of Bezel Back can be measured.

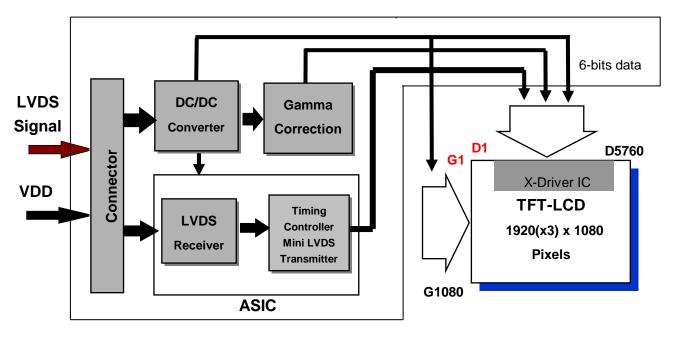




3 TFT-LCD Module

3.1 Block Diagram

The following shows the block diagram of the 21.5 inch Color TFT-LCD Module.



Control



3.2 Interface Connection

3.2.1 Connector Type

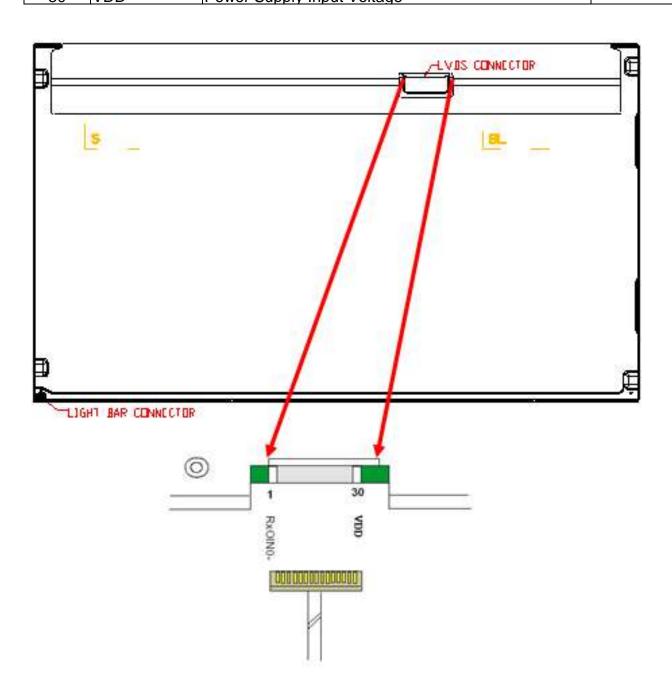
TFT-LCD Connector	Manufacturer	P-TWO	STM	
TI 1-LOD Connector	Part Number	AL230F-A0G1D-P	MSCKT2407P30HB	
Mating Connector	Manufacturer	JAE		
Mating Connector	Part Number	FI-X30HL (Locked Type)		

3.2.2 Connector Pin Assignment

PIN#	Symbol	Description	Remark
1	RxO0-	Negative LVDS differential data input (Odd data)	
2	RxO0+	Positive LVDS differential data input (Odd data)	
3	RxO1-	Negative LVDS differential data input (Odd data)	
4	RxO1+	Positive LVDS differential data input (Odd data)	
5	RxO2-	Negative LVDS differential data input (Odd data)	
6	RxO2+	Positive LVDS differential data input (Odd data)	
7	GND	Ground	
8	RxOCLK-	Negative LVDS differential clock input (Odd clock)	
9	RxOCLK+	Positive LVDS differential clock input (Odd clock)	
10	RxO3-	Negative LVDS differential data input (Odd data)	
11	RxO3+	Positive LVDS differential data input (Odd data)	
12	RxE0-	Negative LVDS differential data input (Even data)	
13	RxE0+	Positive LVDS differential data input (Even data)	
14	GND	Ground	
15	RxE1-	Negative LVDS differential data input (Even data)	
16	RxE1+	Positive LVDS differential data input (Even data)	
17	GND	Ground	
18	RxE2-	Negative LVDS differential data input (Even data)	
19	RxE2+	Positive LVDS differential data input (Even data)	
20	RxECLK-	Negative LVDS differential clock input (Even clock)	
21	RxECLK+	Positive LVDS differential clock input (Even clock)	
22	RxE3-	Negative LVDS differential data input (Even data)	
23	RxE3+	Positive LVDS differential data input (Even data)	
24	GND	Ground	
25	NC	No connection (for ADP test only. Do not connect)	
26	NC	No connection (for ADP test only. Do not connect)	



27	NC	No connection (for ADP test only. Do not connect)	
28	VDD	Power Supply Input Voltage	
29	VDD	Power Supply Input Voltage	
30	VDD	Power Supply Input Voltage	





3.3 Electrical Characteristics

3.3.1 Absolute Maximum Rating

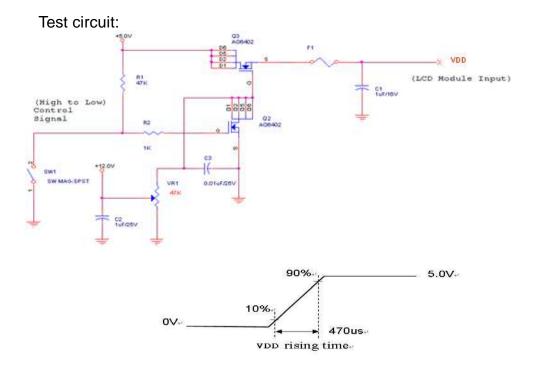
Permanent damage may occur if exceeding the following maximum rating.

Symbol	Description	Min	Max	Unit	Remark
VDD	Power Supply Input Voltage	GND-0.3	6.0	[Volt]	Ta=25°C

3.3.2 Recommended Operating Condition

Symbol	Description	Min	Тур	Max	Unit	Remark
VDD	Power supply Input voltage	4.5	5.0	5.5	[Volt]	
IDD	Power supply	1	0.62	0.74	[A]	VDD= 5.0V, All white Pattern, Fv=60Hz
טטו	Input Current (RMS)		0.7	0.84	[A]	VDD= 5.0V, All white Pattern, Fv=75Hz
PDD	VDD Power	ı	3.1	3.7	[Watt]	VDD= 5.0V, All white Pattern, Fv=60Hz
PDD	Consumption		3.5	4.2	[Watt]	VDD= 5.0V, All white Pattern, Fv=75Hz
IRush	Inrush Current	-	-	3.0	[A]	Note 3-1
VDDrp	Allowable VDD Ripple Voltage	ı	-	500	[mV]	VDD= 5.0V, All white Pattern, Fv=75Hz

Note 3-1: Inrush Current measurement:



The duration of VDD rising time: 470us.

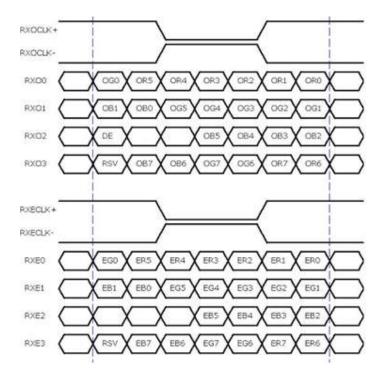


3.4 Signal Characteristics

3.4.1 LCD Pixel Format

		1			2			1	91	9	19	920	C
1st Line	R	G	В	R	G	В		R	G	В	R	G	В
		-			-				-				
		-			-		-		-			-	
		-			-		-		-			•	
		-					- -						
		•			•		•		٠			•	
		•			•		•		•			•	
		•			•		•		٠				
1080 Line	R	G	В	R	G	В		R	G	В	R	G	В

3.4.2 LVDS Data Format



	8 Bit Color Bit Order										
MSB	R7	G7	В7								
	R6	G6	B6								
	R5	G5	B5								
8	R4	G4	B4								
	R3	G3	В3								
	R2	G2	B2								
	R1	G1	B1								
LSB	R0	G0	B0								

Note 3-2:

- a. O = "Odd Pixel Data" E = "Even Pixel Data"
- b. Refer to 3.4.1 LCD pixel format, the 1st data is 1 (Odd Pixel Data), the 2nd data is 2 (Even Pixel Data) and the last data is 1920 (Even Pixel Data).



3.4.3 Color versus Input Data

The following table is for color versus input data (8bit). The higher the gray level, the brighter the color.

												Col	or Inp	ut D	ata											
Color	Gray Level					data , LS E						G (MSI	– –	N dat		l						data LSE)		Remark
		R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	G0	В7	B6	B5	B4	В3	B2	B1	B0	
Black	-	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
White	-	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	
Gray 127	-	0	1	1	1	1	1	1	1	0	1	1	1	1	1	1	1	0	1	1	1	1	1	1	1	
	ம	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
Red	:	• • •		:	:	:		:	:	:	:	:		:	:	:	:	:	:	:	:	:	:	:	:	
	L255	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	ம	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
Green	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	L255	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	
	ம	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
Blue	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	L255	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	



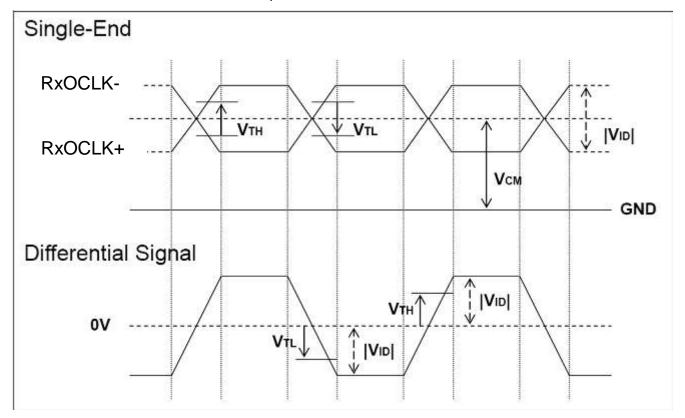
3.4.4 LVDS Specification

a. DC Characteristics:

Symbol	Description	Min	Тур	Max	Units	Condition
V_{TH}	LVDS Differential		-	+100	[mV]	V _{CM} = 1.2V
VIH	Input High Threshold	_	_	+100	[IIIV]	VCM — 1.2 V
V_{TL}	LVDS Differential	-100	_	_	[mV]	V _{CM} = 1.2V
VIL	Input Low Threshold	-100	_	-	[IIIV]	VCM = 1.2 V
V _{ID}	LVDS Differential	100	_	600	[mV]	
VID	Input Voltage	100	-	000	[IIIV]	
\/	LVDS Common Mode	+1.0	+1.2	+1.5	Γ\ /1	V_{TH} - V_{TL} = 200m V
V _{CM}	Voltage	+1.0	+1. 2	+1.5	[V]	VTH-VTL = 200111V

LVDS Signal Waveform:

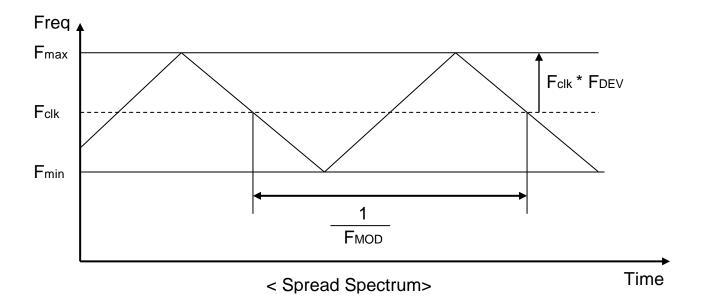
Use RxOCLK- & RxOCLK+ as example.



b. AC Characteristics:



Symbol	Description	Min	Max	Unit	Remark
F _{DEV}	Maximum deviation of input clock frequency during Spread Spectrum	•	± 3	%	
F _{MOD}	Maximum modulation frequency of input clock during Spread Spectrum	1	200	KHz	



Fclk: LVDS Clock Frequency



3.4.5 Input Timing Specification

It only support DE mode, and the input timing are shown as the following table.

Symbol	Descript	ion	Min.	Тур.	Max.	Unit	Remark
Tv		Period	1092	1130	1793	Th	Tv
Tdisp (v)	Vertical Section	Active	1080	1080	1080	Th	Tdisp (v)
Tblk (v)		Blanking	12	50	713	Th	Tblk (v)
Fv		Frequency	50	60	76	Hz	Fv
Th		Period	1004	1050	1100	Tclk	Th
Tdisp (h)	Horizontal Section	Active	960	960	960	Tclk	Tdisp (h)
Tblk (h)		Blanking	44	90	140	Tclk	Tblk (h)
Fh		Frequency	55	68	90	KHz	Fh
Tclk	LVDS Clock	Period	11.1	14.0	18.2	ns	Tclk
Fclk	2,20 0.00	Frequency	54.8	71.2	90.0	MHz	Fclk

Note 3-3: The equation is listed as following. Please don't exceed the above recommended value.

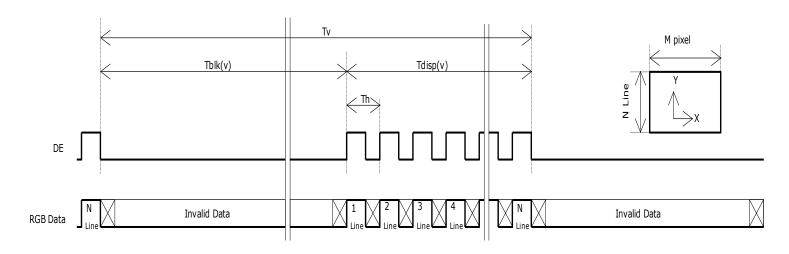
Fh (Min.) = Fclk (Min.) / Th (Min.); Fh (Typ.) = Fclk (Typ.) / Th (Typ.); Fh (Max.)= Fclk (Max.) / Th (Min.);

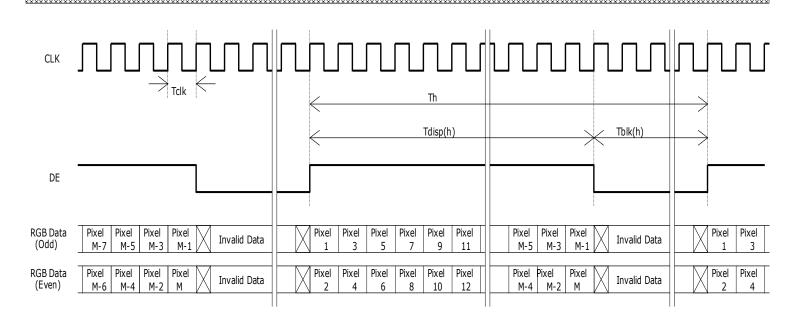
Note 3-4: The equation is listed as following. Please don't exceed the above recommended value.

Fclk (Min.) = Fv (Min.) x Th (Min.) x Tv (Min.); Fclk (Typ.) = Fv (Typ.) x Th (Typ.) x Tv (Typ.); Fclk (Max.) = Fv (Max.) x Th (Typ.) x Tv (Typ.);



3.4.6 Input Timing Diagram

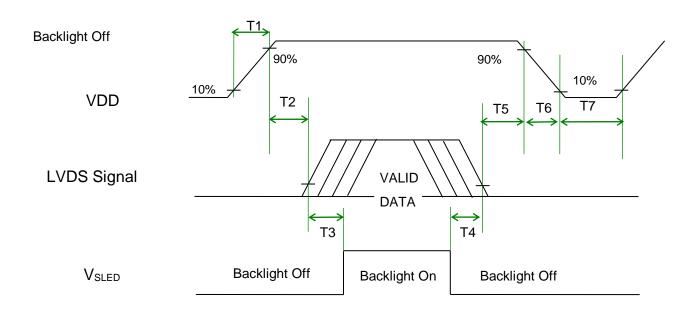






3.5 Power ON/OFF Sequence

VDD power,LVDS signal and backlight on/off sequence are as following. LVDS signals from any system shall be Hi-Z state when VDD is off.



Power Sequence Timing

Symbol		Value	I I m i f	Remark			
Symbol	Min.	Тур.	Max.	Unit			
T1	0.5	-	10	[ms]			
T2	0	-	50	[ms]			
T3	500	-	-	[ms]			
T4	100	-	-	[ms]			
T5	0		50	[ms]	Note 3-5 Note 3-6		
T6	0	-	200	[ms]	Note 3-7		
T7	1000	-	-	[ms]			

Note 3-5: Recommend setting T5 = 0ms to avoid electronic noise when VDD is off.

Note 3-6: During T5 and T6 period, please keep the level of input LVDS signals with Hi-Z state.

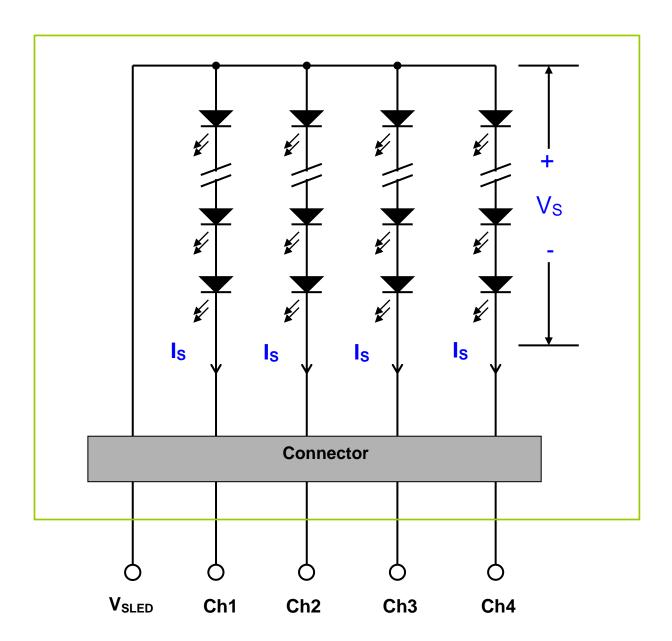
Note 3-7: Voltage of VDD must decay smoothly after power-off. (customer system decide this value)



4 Backlight Unit

4.1 Block Diagram

The following shows the block diagram of the 21.5 inch Backlight Unit. And it includes 60 pcs LED in the LED light bar. (4 strings and 15 pcs LED of one string).





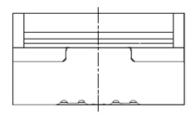
4.2 Interface Connection

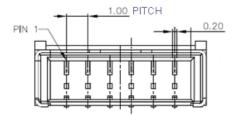
4.2.1 Connector Type

Backlight Connector	Manufacturer	ENTERY
Backlight Connector	Part Number	3707K-S06N-21R
	Manufacturer	ENTERY
Mating Connector	Part Number	H112K-P06N-00B (Non-Locking type) H112K-P06N-03B (Locking type)

Backlight Connector dimension:

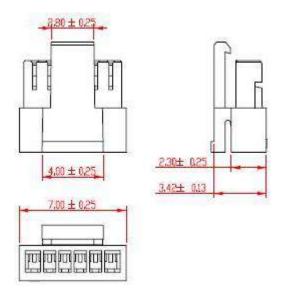
$$H \times V \times D = 13.9 \times 3.00 \times 4.25$$
, $Pitch = 1.0(unit = mm)$

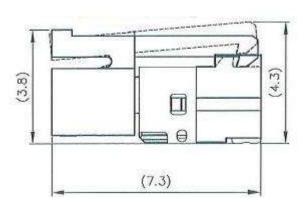






Mating Connector dimension:

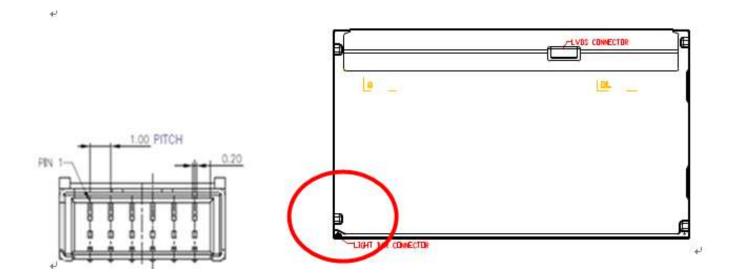






4.2.2 Connector Pin Assignment

Pin#	Symbol	Description	Remark
1	Ch1	LED Current Feedback Terminal (Channel 1)	
2	Ch2	LED Current Feedback Terminal (Channel 2)	
3	VSLED	LED Power Supply Voltage Input Terminal	
4	VSLED	LED Power Supply Voltage Input Terminal	
5	Ch3	LED Current Feedback Terminal (Channel 3)	
6	Ch4	LED Current Feedback Terminal (Channel 4)	





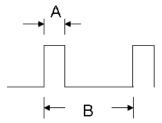
4.3 Electrical Characteristics

4.3.1 Absolute Maximum Rating

Permanent damage may occur if exceeding the following maximum rating.

(Ta=25°ℂ)

Symbol	Description	Min	Max	Unit	Remark	
	LED String Current	0	90	[mA]	100% duty ratio	
ls			150	[mA]	Duty ratio≦ 10% Pulse time=10 ms	



Duty ratio= (A / B) X 100%; (A: Pulse time, B: Period)

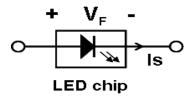
4.3.2 Recommended Operating Condition

(Ta=25°C)

Symbol	Description	Min.	Тур.	Max.	Unit	Remark
ls	LED String Current	-	60	66	[mA]	100% duty ratio of LED chip <i>Note 4-6</i>
Vs	LED String Voltage	-	46.5	51	[Volt]	Is=60mA @ 100% duty ratio; <i>Note 4-1, Note</i> <i>4-5, Note 4-7</i>
ΔVs	Maximum Vs Voltage Deviation of light bar	-	-	3	[Volt]	Is=60mA @ 100% duty ratio; <i>Note 4-2</i>
P _{BLU}	LED Light Bar Power Consumption	-	11.2	12.2	[Watt]	Note 4-3
LT _{LED}	LED Life Time	30,000	-	-	[Hour]	Note 4-4
OVP	Over Voltage Protection in system board	110% Vsmax	-	-	[Volt]	Note 4-5



- **Note 4-1:** Vs (Typ.) = V_F (Typ.) X LED No. (one string);
 - a. V_F : LED chip forward voltage, V_F (Min.)= 2.8V, V_F (Typ.)=3.1V, V_F (Max.)=3.4V b. The same euqation to calculate Vs(Min.) & Vs (Max.) for respective V_F (Min.) & V_F (Max.);



- **Note 4-2:** ΔVs (Max.) = $\Delta V_F X LED$ No. (one string);
 - a. ΔV_F LED chip forward voltage deviation; (0.2 V, each Bin of LED V_F)
- **Note 4-3:** P_{BLU} (Typ.) = Vs (Typ.) X Is (Typ.) X 4; (4 is total String No. of LED Light bar) P_{BLU} (Max.) = Vs (Max.) X Is (Typ.) X 4;
- **Note 4-4:** Definition of life time:
 - a. Brightness of LED becomes to 50% of its original value
 - b. Test condition: Is = 60mA and 25° C (Room Temperature)
- Note 4-5: Recommendation for LED driver power design:

 Due to there are electrical property deviation in LED & monitor set system component after long time operation. ADP strongly recommend the design value of LED driver board OVP (over voltage protection) should be 10% higher than max. value of LED string voltage (Vs) at least.
- **Note 4-6:** ADP strongly recommend "Analog Dimming" method for backlight brightness control for Wavy Noise Free. Otherwise, recommend that Dimming Control Signal (PWM Signal) should be synchronized with Frame Frequency.
- **Note 4-7:** Ensure that the LED light bar is not subjected either forward or reverse voltage while monitor set is on standby mode or not in use.



5 Reliability Test

ADP reliability test items are listed as following table. (Bare Panel only)

Items	Condition	Remark	
Ta= 50°C, 80%RH, 300hours			
High Temperature Operation (HTO)	Ta= 50°C, 50%RH, 300hours		
Low Temperature Operation (LTO)	Ta= 0°C, 300hours		
High Temperature Storage (HTS)	Ta= 60°C, 300hours		
Low Temperature Storage (LTS)	Ta= -20°C, 300hours		
Vibration Test (Non-operation)	Acceleration: 1.5 Grms Wave: Random Frequency: 10 - 200 Hz Sweep: 30 Minutes each Axis (X, Y, Z)		
Shock Test (Non-operation)	Acceleration: 50 G Wave: Half-sine Active Time: 20 ms Direction: ±X, ±Y, ±Z (one time for each Axis)		
Thermal Shock Test (TST)	-20°C/30min, 60°C/30min, 100 cycles	Note 5-1	
On/Off Test	On/10sec, Off/10sec, 30,000 cycles		
ESD (Electro Static Discharge)	Contact Discharge: \pm 15KV, 150pF(330 Ω) 1sec, 8 points, 25 times/ point.	Note 5-2	
LOD (Liectio Static Discharge)	Air Discharge: ± 15KV, 150pF(330Ω) 1sec 8 points, 25 times/ point.	140te 3-2	
Altitude Test	Operation:18,000 ft Non-Operation:40,000 ft		

- **Note 5-1**: a. A cycle of rapid temperature change consists of varying the temperature from -20°C to 60°C, and back again. Power is not applied during the test.
 - b. After finish temperature cycling, the unit is placed in normal room ambient for at least 4 hours before power on.

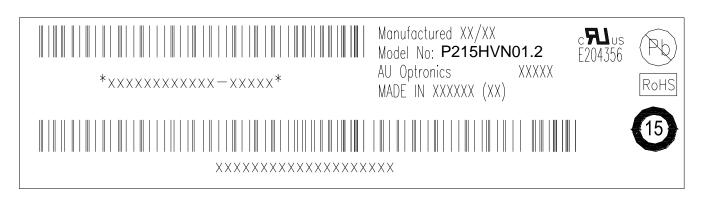
Note 5-2: EN61000-4-2, ESD class B: Certain performance degradation allowed

No data lost Self-recoverable No hardware failures.



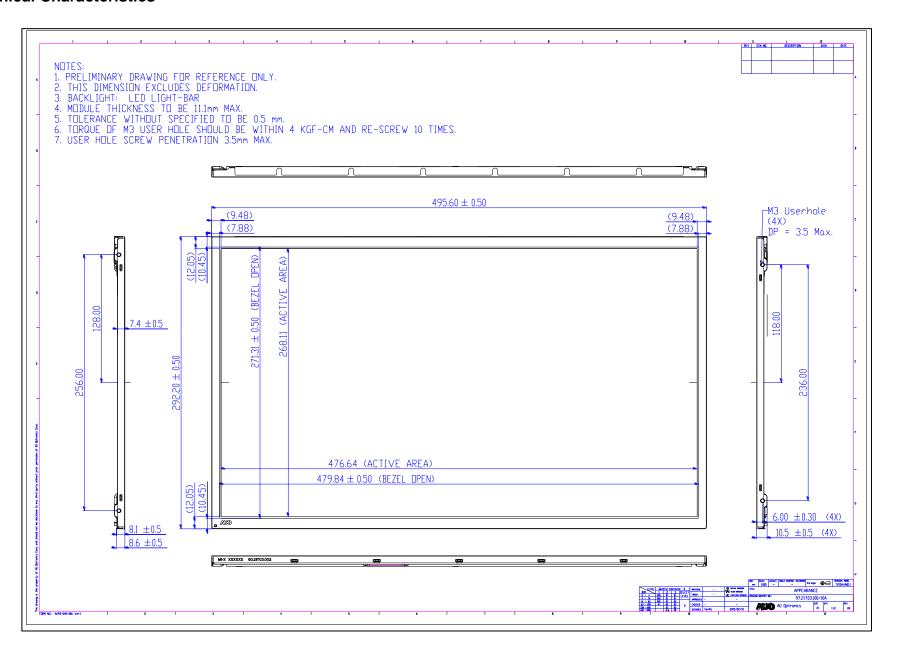
6 Shipping Label

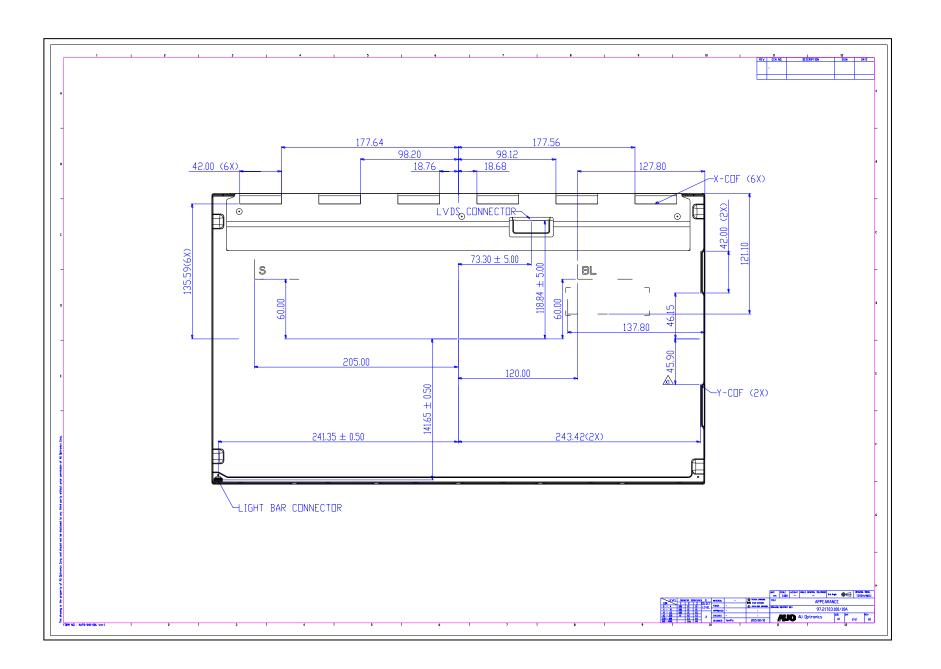
The label is on the panel as shown below:



- Note 6-1: For Pb Free products, ADP will add for identification.
- Note 6-2: For RoHS compatible products, ADP will add RoHS for identification.
- Note 6-3: For China RoHS compatible products, ADP will add of for identification.
- **Note 6-4:** The Green Mark will be presented only when the green documents have been ready by ADP Internal Green Team.

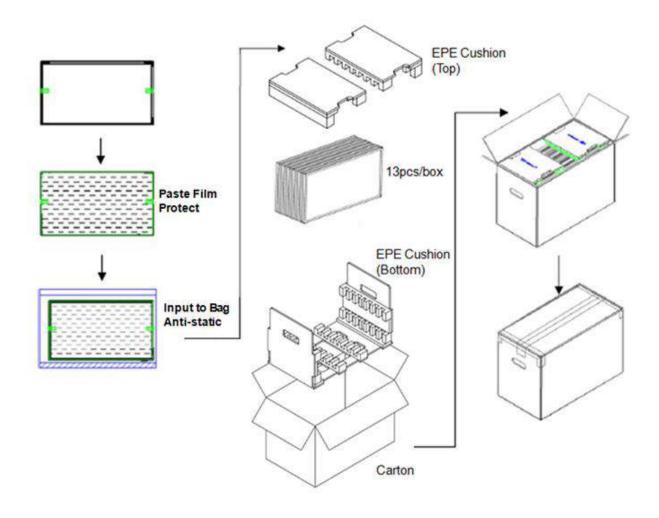
7 Mechanical Characteristics

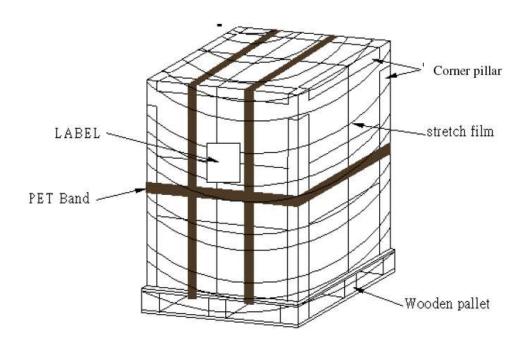




8 Packing Specification

8.1 Packing Flow





Single pallet stack Illustration

8.2 Pallet and shipment information

	ltem		Damark			
	item	Q'ty	Dimension	Weight(kg)	Remark	
1	Panel	1	495.6(H)mm x 292.2(V)mm x 10.6(D)mm	1.67	Note 1	
2	Cushion	1		0.56		
3	Box	1	565(L)mm x 345(W)mm x 375(H)mm	1.4	without Panel & cushion Note 1	
4	Packing Box	13 pcs/Box	565(L)mm x 345(W)mm x 375(H)mm	24	with panel & cushion Note 1	
5	Pallet	1	1150(L)mm x 1070(W)mm x 132(H)mm	12	Note 1	
6	Pallet after Packing	18boxes/pallet	1150(L)mm x 1070(W)mm x 1257(H)mm	432	Note 1	

Note 1: Estimated value which is subject to change based on real measured data.